

T250924C 2025.09.24

Technical Data Sheet Residue-less Flux for Area Laser Applications RLFP008



Properties

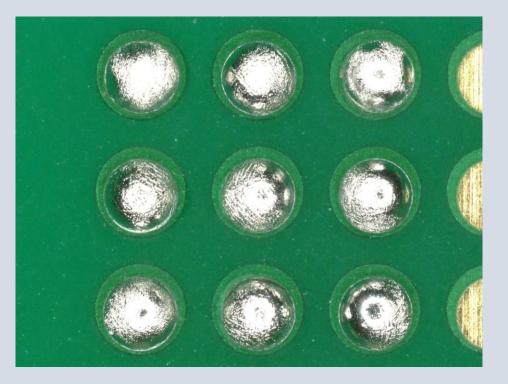
	Value	Method
Viscosity (Pa·s)	13	Rheometer (NETZSCH, Kinexus)
Thixotropic Index	0.43	Rheometer (NETZSCH, Kinexus)
pH (1g, 30mL IPA)	4.25	Titration
Acid Value (mgKOH/g)	23.85	JIS 3197 8.1.4.1.1
Halide Contents (wt%)	Not added	JIS 3197 8.1.4.2.1
Tackiness (gf)	130	JIS Z 3284-3 4.5

Residue

Test Conditions

[Mask] Aperture size φ 0.3mm t30μm
[Substrate] Pad size φ 0.3mm ENIG
[Component] SAC305 Solder Ball φ 0.3mm
[Heating] Size 50mm x 50mm, Power 2000W, Time 2sec
[Device] Printer (YAMAHA, YCP10), Area Laser (LASERSSEL, LSR 3000)

Test Results



Achieving low residue with short-time heating by an area laser.



Wettability

Test Conditions

(Mask) Aperture size ϕ 0.3mm t30 μ m (Substrate) Pad size ϕ 0.3mm ENIG (Component) SAC305 Solder Ball ϕ 0.3mm (Heating) Size 50mm x 50mm, Power 2000W, Time 2sec (Device) Printer (YAMAHA, YCP10), Area Laser (LASERSSEL, LSR 3000)

Test Results



Good wettability is achieved by short-time heating using an area laser.



Continuous Printing Evaluation——Viscosity & TI

Test Conditions

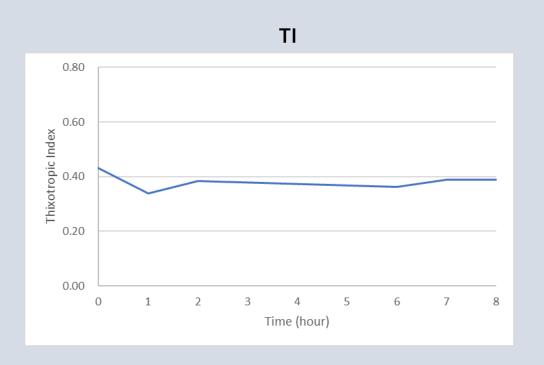
[Printing] Speed: 15mm/s, Interval: 10sec

[Environment Conditions] Temperature 24°C, Humidity 35%

[Device] Printer (Hitachi, HIGRAD HG-610), Rheometer (NETZSCH, Kinexus)

Test Results





Stable viscosity and TI over 8 hours of continuous printing.



Tackiness

Test Conditions

[Mask] Aperture ϕ 6.5mm t200 μ m

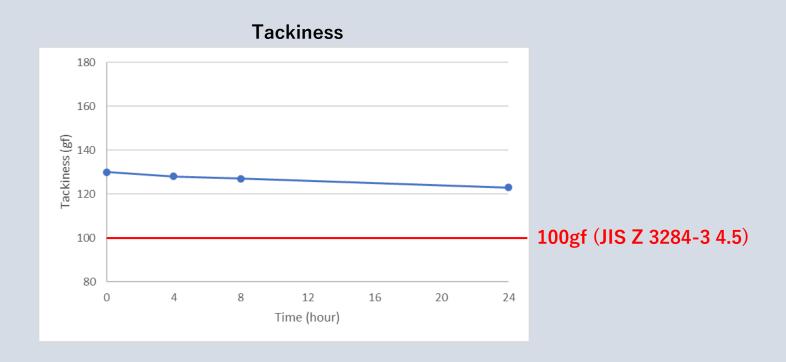
[Probe Diameter] ϕ 5.1mm [Maintaining Pressure] 50gf

[Pressure Time] 0.2sec [Permeation Rate] 2.0mm/sec

[Device] Tacking Tester (Malcom, TK-1S)

【Retraction Speed】 10mm/sec

Test Results



• Tackiness remains above 100 gf for 24 hours.



Caution in use

- ① Do not use this product for other purposes except soldering.
- ② Do not touch this product directly. In case of skin contact, wipe with tissue or cloth with alcohol or appropriate solvent then wash by soap water.
- 3 Do not inhale fume generated from this product. Adequate ventilation is required.
- ④ Recommended storage condition and quality guarantee period are as follows: Keep refrigerated $(0-10^{\circ}C)$: 3 months from manufacturing date.
- ⑤ When it backs to room temperature (24℃), avoid to heat too rapidly.

 Keep it at room temperature and wait for 1-2 hours. Do not use it when it is refrigerated.
- 6 Chlorinated or fluorinated solvents or other type of solvents will cause degrading of solderability. Please be careful in cleaning of supplying tools.
- ⑦ Please keep it away from any fire source in working place or store room.